

# MC14521B

## 24-Stage Frequency Divider

The MC14521B consists of a chain of 24 flip-flops with an input circuit that allows three modes of operation. The input will function as a crystal oscillator, an RC oscillator, or as an input buffer for an external oscillator. Each flip-flop divides the frequency of the previous flip-flop by two, consequently this part will count up to  $2^{24} = 16,777,216$ . The count advances on the negative going edge of the clock. The outputs of the last seven-stages are available for added flexibility.

### Features

- All Stages are Resettable
- Reset Disables the RC Oscillator for Low Standby Power Drain
- RC and Crystal Oscillator Outputs Are Capable of Driving External Loads
- Test Mode to Reduce Test Time
- $V_{DD}'$  and  $V_{SS}'$  Pins Brought Out on Crystal Oscillator Inverter to Allow the Connection of External Resistors for Low-Power Operation
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load over the Rated Temperature Range
- These Devices are Pb-Free and are RoHS Compliant

### MAXIMUM RATINGS (Voltages Referenced to $V_{SS}$ )

Parameter	Symbol	Value	Unit
DC Supply Voltage Range	$V_{DD}$	-0.5 to +18.0	V
Input or Output Voltage Range (DC or Transient)	$V_{in}, V_{out}$	-0.5 to $V_{DD}$ +0.5	V
Input or Output Current (DC or Transient) per Pin	$I_{in}, I_{out}$	±10	mA
Power Dissipation, per Package (Note 1)	$P_D$	500	mW
Ambient Temperature Range	$T_A$	-55 to +125	°C
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Lead Temperature (8-Second Soldering)	$T_L$	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Temperature Derating: Plastic "P and D/DW"  
Packages: - 7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

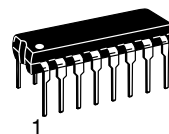
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.



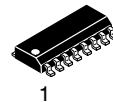
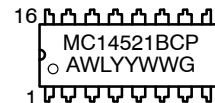
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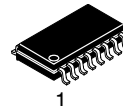
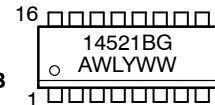
### MARKING DIAGRAMS



PDIP-16  
P SUFFIX  
CASE 648



SOIC-16  
D SUFFIX  
CASE 751B



SOEIAJ-16  
F SUFFIX  
CASE 966



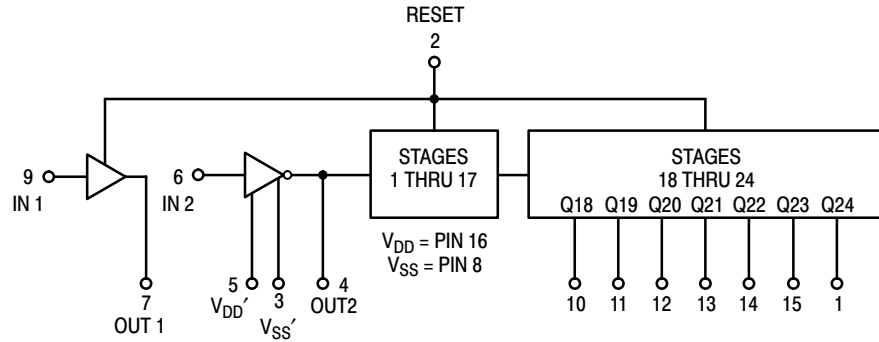
A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week  
G = Pb-Free Package

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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## BLOCK DIAGRAM



### PIN ASSIGNMENT

Q24	1 ●	16	V <sub>DD</sub>
RESET	2	15	Q23
V <sub>SS</sub> '	3	14	Q22
OUT 2	4	13	Q21
V <sub>DD</sub> '	5	12	Q20
IN 2	6	11	Q19
OUT 1	7	10	Q18
V <sub>SS</sub>	8	9	IN 1

Output	Count Capacity
Q18	2 <sup>18</sup> = 262,144
Q19	2 <sup>19</sup> = 524,288
Q20	2 <sup>20</sup> = 1,048,576
Q21	2 <sup>21</sup> = 2,097,152
Q22	2 <sup>22</sup> = 4,194,304
Q23	2 <sup>23</sup> = 8,388,608
Q24	2 <sup>24</sup> = 16,777,216

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MC14521BCPG	PDIP-16 (Pb-Free)	500 Units / Rail
MC14521BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14521BDR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
MC14521BFG	SOEIAJ-16 (Pb-Free)	50 Units / Rail
MC14521BFELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## ELECTRICAL CHARACTERISTICS (Voltages Referenced to $V_{SS}$ )

Characteristic	Symbol	$V_{DD}$ Vdc	- 55°C		25°C			125°C		Unit	
			Min	Max	Min	Typ (Note 2)	Max	Min	Max		
Output Voltage $V_{in} = V_{DD}$ or 0  $V_{in} = 0$ or $V_{DD}$	$V_{OL}$	5.0	-	0.05	-	0	0.05	-	0.05	Vdc	
		10	-	0.05	-	0	0.05	-	0.05		
15		-	0.05	-	0	0.05	-	0.05			
	$V_{OH}$	5.0	4.95	-	4.95	5.0	-	4.95	-	Vdc	
		10	9.95	-	9.95	10	-	9.95	-		
		15	14.95	-	14.95	15	-	14.95	-		
Input Voltage ( $V_O = 4.5$ or $0.5$ Vdc) ( $V_O = 9.0$ or $1.0$ Vdc) ( $V_O = 13.5$ or $1.5$ Vdc)	$V_{IL}$	5.0	-	1.5	-	2.25	1.5	-	1.5	Vdc	
		10	-	3.0	-	4.50	3.0	-	3.0		
15		-	4.0	-	6.75	4.0	-	4.0			
( $V_O = 0.5$ or $4.5$ Vdc) ( $V_O = 1.0$ or $9.0$ Vdc) ( $V_O = 1.5$ or $13.5$ Vdc)	$V_{IH}$	5.0	3.5	-	3.5	2.75	-	3.5	-	Vdc	
		10	7.0	-	7.0	5.50	-	7.0	-		
		15	11	-	11	8.25	-	11	-		
Output Drive Current ( $V_{OH} = 4.5$ Vdc) Source ( $V_{OH} = 9.0$ Vdc) Pin 4 ( $V_{OH} = 13$ Vdc)  ( $V_{OH} = 2.5$ Vdc) Source ( $V_{OH} = 4.6$ Vdc) Pins 1, 7, 10, ( $V_{OH} = 9.5$ Vdc) 11, 12, 13, 14 ( $V_{OH} = 13.5$ Vdc) and 15 ( $V_{OL} = 0.4$ Vdc) Sink ( $V_{OL} = 0.5$ Vdc) ( $V_{OL} = 1.5$ Vdc)	$I_{OH}$	5.0	-0.25	-	-0.2	-0.36	-	-0.14	-	mAdc	
		10	-0.62	-	-0.5	-0.9	-	-0.35	-		
		15	-1.8	-	-1.5	-3.5	-	-1.1	-		
			5.0	-3.0	-	-2.4	-4.2	-	-1.7	-	mAdc
5.0			-0.64	-	-0.51	-0.88	-	-0.36	-		
10			-1.6	-	-1.3	-2.25	-	-0.9	-		
		15	-4.2	-	-3.4	-8.8	-	-2.4	-	mAdc	
		5.0	0.64	-	0.51	0.88	-	0.36	-		mAdc
		10	1.6	-	1.3	2.25	-	0.9	-		
15	4.2	-	3.4	8.8	-	2.4	-				
Input Current	$I_{in}$	15	-	$\pm 0.1$	-	$\pm 0.00001$	$\pm 0.1$	-	$\pm 1.0$	$\mu$ Adc	
Input Capacitance ( $V_{in} = 0$ )	$C_{in}$	-	-	-	-	5.0	7.5	-	-	pF	
Quiescent Current (Per Package)	$I_{DD}$	5.0	-	5.0	-	0.005	5.0	-	150	$\mu$ Adc	
		10	-	10	-	0.010	10	-	300		
		15	-	20	-	0.015	20	-	600		
Total Supply Current (Note 3, 4) (Dynamic plus Quiescent, Per Package) ( $C_L = 50$ pF on all outputs, all buffers switching)	$I_T$	5.0 10 15	$I_T = (0.42 \mu\text{A/kHz}) f + I_{DD}$ $I_T = (0.85 \mu\text{A/kHz}) f + I_{DD}$ $I_T = (1.40 \mu\text{A/kHz}) f + I_{DD}$								$\mu$ Adc

2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25°C.

4. To calculate total supply current at loads other than 50 pF:  $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) V f k$  where:  $I_T$  is in  $\mu\text{A}$  (per package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts,  $f$  in kHz is input frequency, and  $k = 0.003$ .

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## SWITCHING CHARACTERISTICS (Note 5) ( $C_L = 50 \text{ pF}$ , $T_A = 25^\circ\text{C}$ )

Characteristic	Symbol	V <sub>DD</sub> Vdc	Min	Typ (Note 6)	Max	Unit
Output Rise and Fall Time (Counter Outputs) $t_{TLH}, t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$ $t_{TLH}, t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$ $t_{TLH}, t_{THL} = (0.55 \text{ ns/pF}) C_L + 12.5 \text{ ns}$	$t_{TLH}, t_{THL}$	5.0 10 15	– – –	100 50 40	200 100 80	ns
Propagation Delay Time Clock to Q18 $t_{PHL}, t_{PLH} = (1.7 \text{ ns/pF}) C_L + 4415 \text{ ns}$ $t_{PHL}, t_{PLH} = (0.66 \text{ ns/pF}) C_L + 1667 \text{ ns}$ $t_{PHL}, t_{PLH} = (0.5 \text{ ns/pF}) C_L + 1275 \text{ ns}$ Clock to Q24 $t_{PHL}, t_{PLH} = (1.7 \text{ ns/pF}) C_L + 5915 \text{ ns}$ $t_{PHL}, t_{PLH} = (0.66 \text{ ns/pF}) C_L + 2167 \text{ ns}$ $t_{PHL}, t_{PLH} = (0.5 \text{ ns/pF}) C_L + 1675 \text{ ns}$	$t_{PHL}, t_{PLH}$	5.0 10 15  5.0 10 15	– – –  – – –	4.5 1.7 1.3  6.0 2.2 1.7	9.0 3.5 2.7  12 4.5 3.5	$\mu\text{s}$
Propagation Delay Time Reset to Q <sub>n</sub> $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 1215 \text{ ns}$ $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 467 \text{ ns}$ $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 350 \text{ ns}$	$t_{PHL}$	5.0 10 15	– – –	1300 500 375	2600 1000 750	ns
Clock Pulse Width	$t_{WH(cl)}$	5.0 10 15	385 150 120	140 55 40	– – –	ns
Clock Pulse Frequency	$f_{cl}$	5.0 10 15	– – –	3.5 9.0 12	2.0 5.0 6.5	MHz
Clock Rise and Fall Time	$t_{TLH}, t_{THL}$	5.0 10 15	– – –	– – –	15 5.0 4.0	$\mu\text{s}$
Reset Pulse Width	$t_{WH(R)}$	5.0 10 15	1400 600 450	700 300 225	– – –	ns
Reset Removal Time	$t_{rem}$	5.0 10 15	30 0 –40	–200 –160 –110	– – –	ns

5. The formulas given are for the typical characteristics only at 25°C.

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

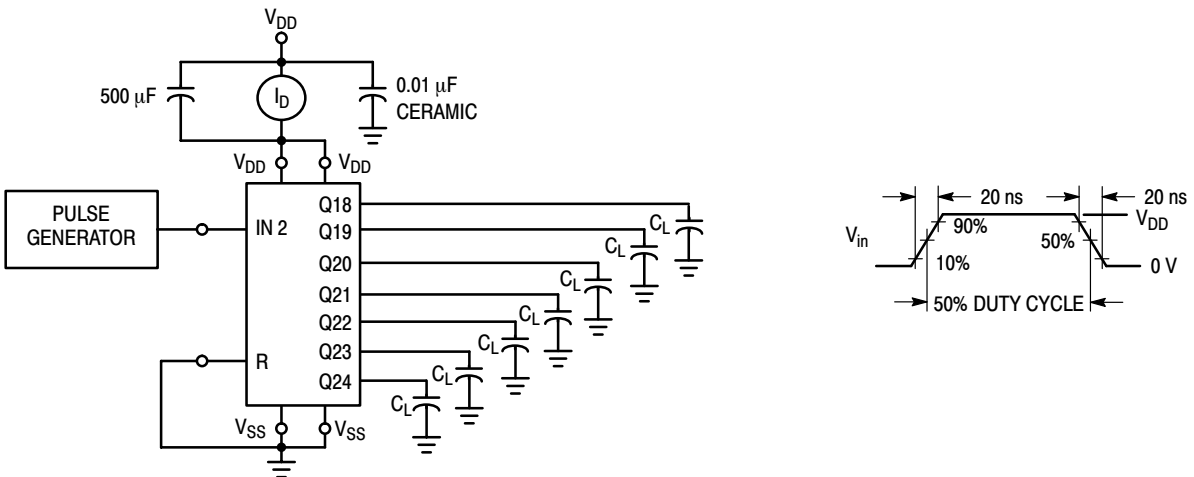


Figure 1. Power Dissipation Test Circuit and Waveform

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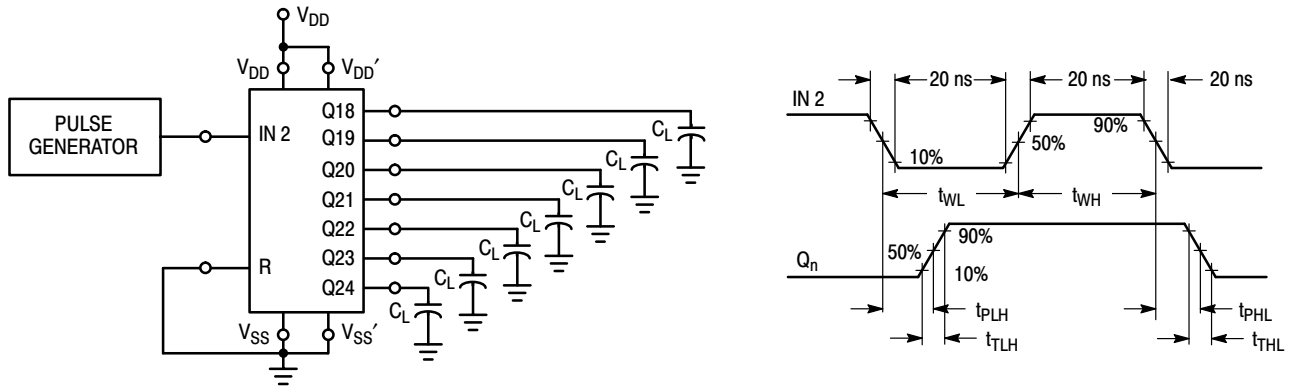
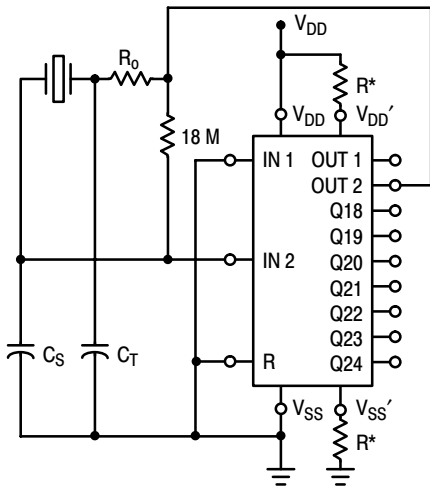


Figure 2. Switching Time Test Circuit and Waveforms



\*Optional for low power operation,  
 $10 \text{ k}\Omega \leq R \leq 70 \text{ k}\Omega$ .

Figure 3. Crystal Oscillator Circuit

Characteristic	500 kHz Circuit	50 kHz Circuit	Unit
Crystal Characteristics			
Resonant Frequency	500	50	kHz
Equivalent Resistance, $R_S$	1.0	6.2	$\text{k}\Omega$
External Resistor/Capacitor Values			
$R_0$	47	750	$\text{k}\Omega$
$C_T$	82	82	pF
$C_S$	20	20	pF
Frequency Stability			
Frequency Change as a Function of $V_{DD}$ ( $T_A = 25^\circ\text{C}$ )			
$V_{DD}$ Change from 5.0 V to 10 V	+ 6.0	+ 2.0	ppm
$V_{DD}$ Change from 10 V to 15 V	+ 2.0	+ 2.0	ppm
Frequency Change as a Function of Temperature ( $V_{DD} = 10 \text{ V}$ )			
$T_A$ Change from $-55^\circ\text{C}$ to $+25^\circ\text{C}$	- 4.0	- 2.0	ppm
MC14521 only	+ 100	+ 120	ppm
Complete Oscillator*			
$T_A$ Change from $+25^\circ\text{C}$ to $+125^\circ\text{C}$	- 2.0	- 2.0	ppm
MC14521 only	- 160	- 560	ppm
Complete Oscillator*			

\*Complete oscillator includes crystal, capacitors, and resistors.

Figure 4. Typical Data for Crystal Oscillator Circuit

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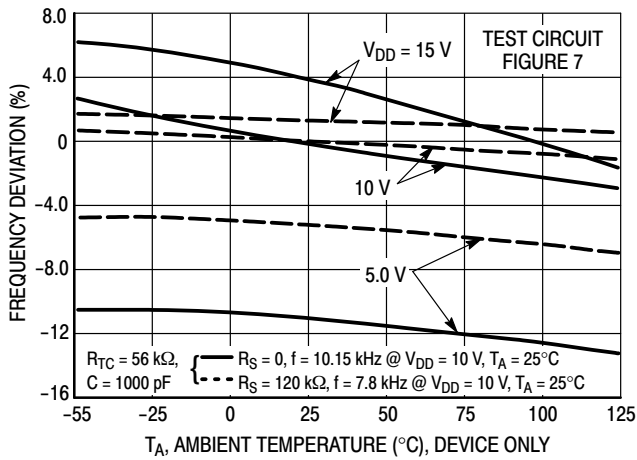


Figure 5. RC Oscillator Stability

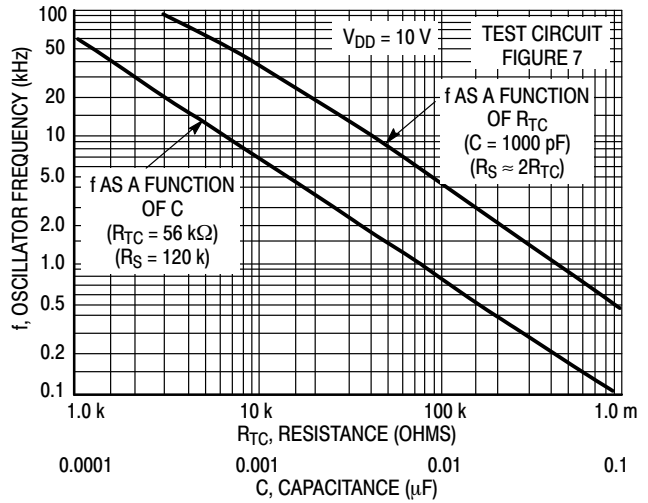


Figure 6. RC Oscillator Frequency as a Function of  $R_{TC}$  and  $C$

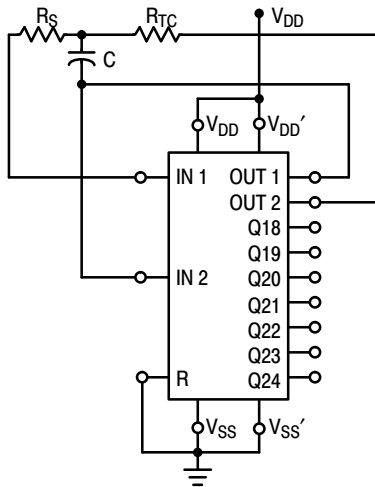


Figure 7. RC Oscillator Circuit

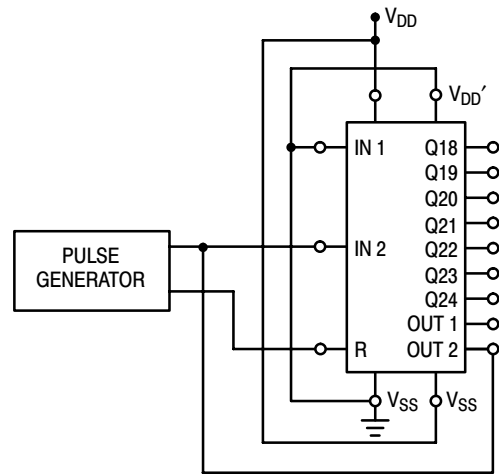


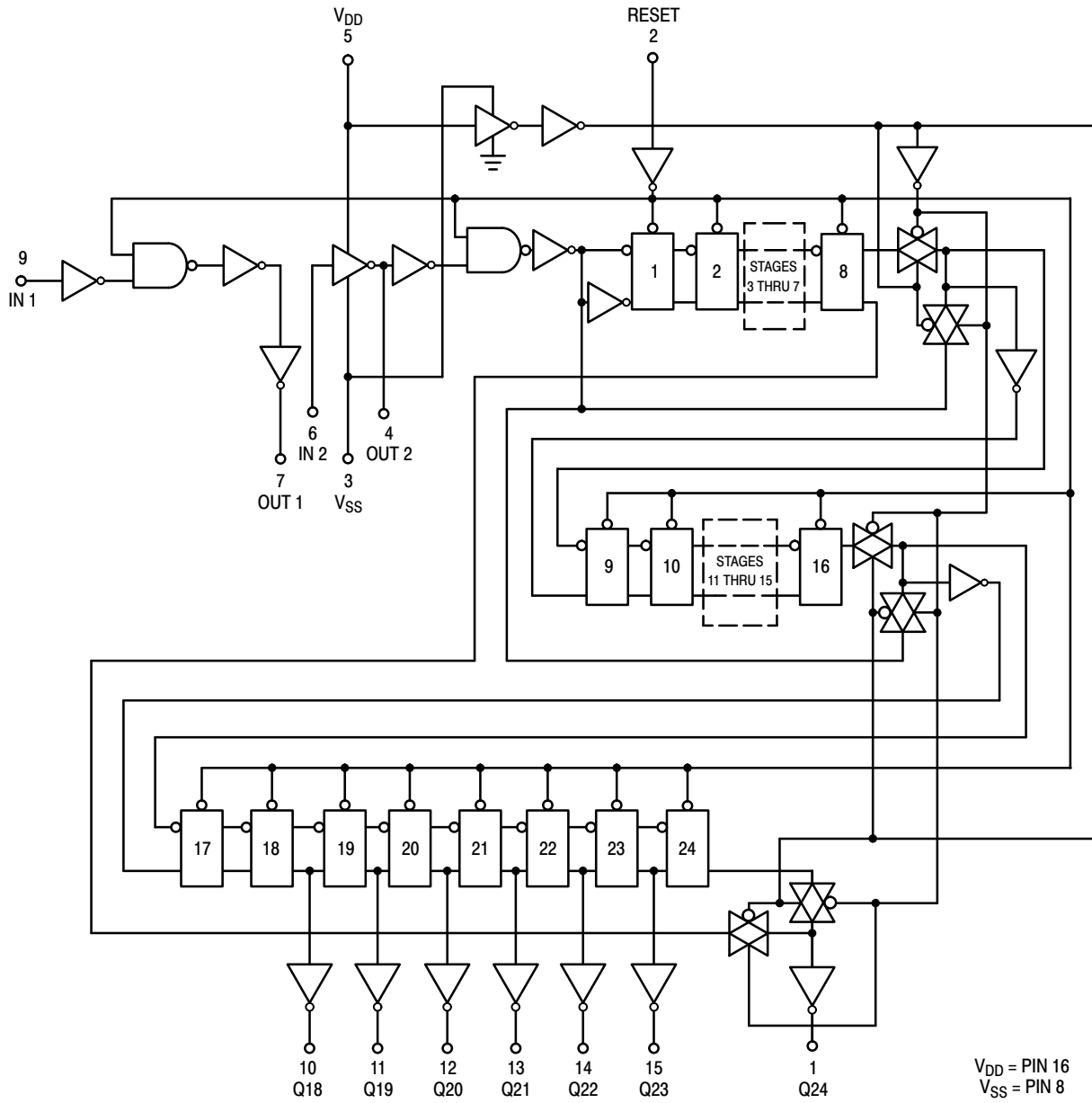
Figure 8. Functional Test Circuit

## FUNCTIONAL TEST SEQUENCE

	Inputs		Outputs			Comments	
	Reset	In 2	Out 2	$V_{SS}'$	$V_{DD}'$		
<p>A test function (see Figure 8) has been included for the reduction of test time required to exercise all 24 counter stages. This test function divides the counter into three 8-stage sections, and 255 counts are loaded in each of the 8-stage sections in parallel. All flip-flops are now at a logic "1". The counter is now returned to the normal 24-stages in series configuration. One more pulse is entered into Input 2 (In 2) which will cause the counter to ripple from an all "1" state to an all "0" state.</p>	1	0	0	$V_{DD}$	GND	Counter is in three 8-stage sections in parallel mode Counter is reset. In 2 and Out 2 are connected together.	
	0	1	1		$V_{DD}$	GND	0
		0	0				255 "0" to "1" transitions are clocked into this In 2, Out 2 node.
		1	1				1
		0	0				1
		0	0				1
	1	0	1	GND	$V_{DD}$	1	
	1	0				1	
	0	1				0	

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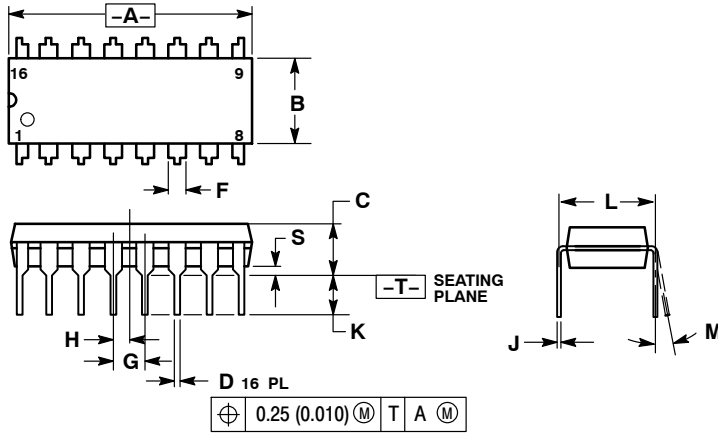
## LOGIC DIAGRAM



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## PACKAGE DIMENSIONS

### PDIP-16 CASE 648-08 ISSUE T

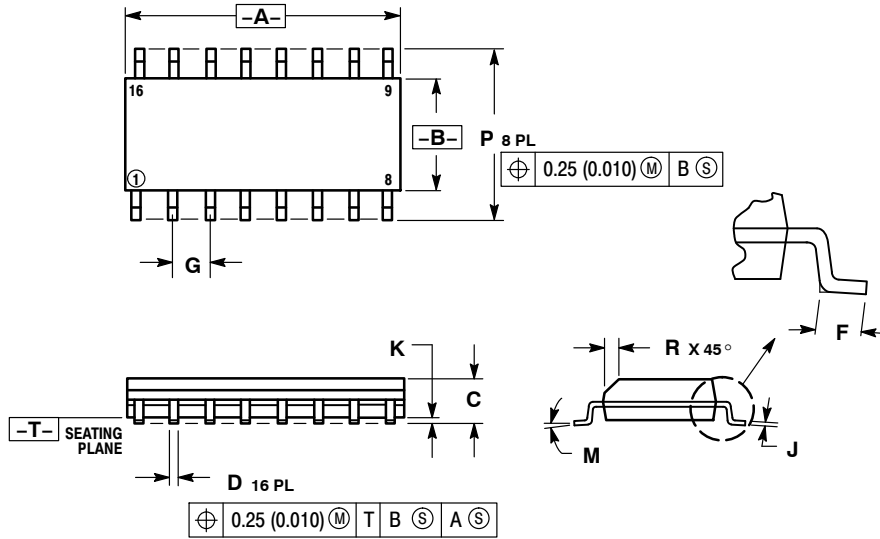


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°		10°	
S	0.020	0.040	0.51	1.01

### SOIC-16 CASE 751B-05 ISSUE K

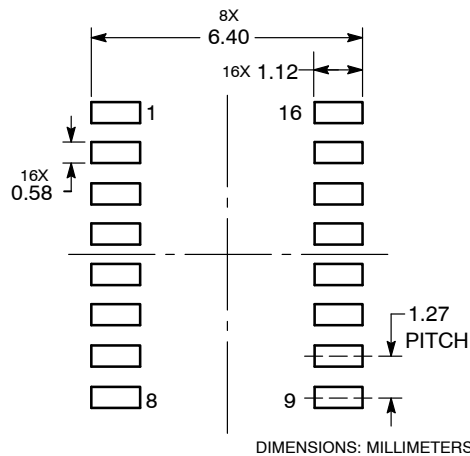


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°		7°	
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

### SOLDERING FOOTPRINT

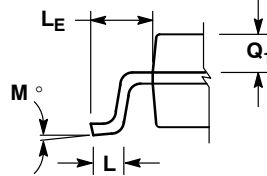
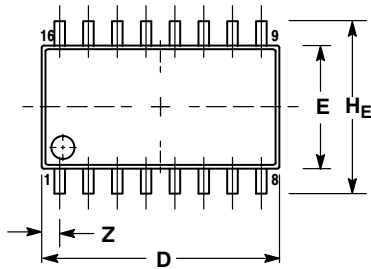




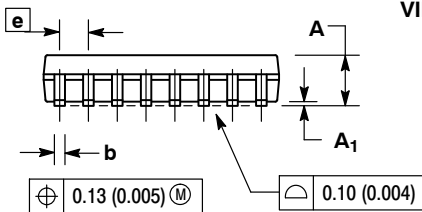
# MC14521B

## PACKAGE DIMENSIONS

SOEIAJ-16  
CASE 966-01  
ISSUE A



DETAIL P



VIEW P

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H <sub>E</sub>	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L <sub>E</sub>	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z	---	0.78	---	0.031

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